

IFW  
Application No. 09/313,659  
SEC.0636  
STATUS REQUEST  
January 19, 2007

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent application of :  
Won-suk Yang et al. : Mail Stop Petitions  
Serial No. 09/313,659 : Office of Petitions  
Filed May 18, 1999 :

MULTILAYER INTERCONNECTION STRUCTURE OF A SEMICONDUCTOR

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SECOND STATUS INQUIRY

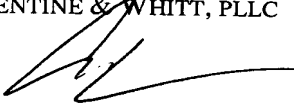
U.S. Patent and Trademark Office  
**Customer Window, Mail Stop Amendment**  
Randolph Building  
401 Dulany Street  
Alexandria, VA 22314

Sir:

Applicants received a favorable Decision On Petition dated July 8, 2006. The Decision indicated that the application would be return to the Examiner for further prosecution. To date, Applicants have received no further communications from the Examiner.

**Please immediately inform the undersigned as to the status of the present application, and in particular, when issuance of a communication on the merits is anticipated.**

Respectfully submitted,  
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